

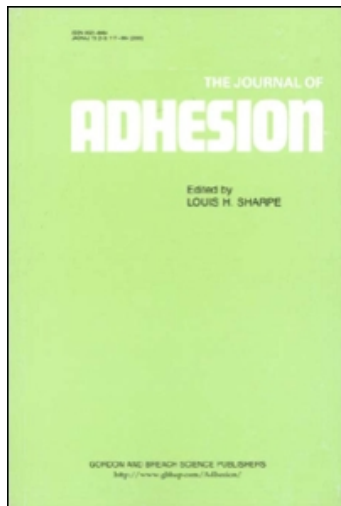
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Calendar of Events

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CALENDAR OF EVENTS

2005

November 2–4, 2005, Announcement and Call for Papers, “Wood Adhesives 2005”, Holiday Inn on the Bay, San Diego, California, USA. This is the eighth in a series of symposia sponsored every 5 years by the USDA Forest Service, Forest Products Laboratory, designed to provide a comprehensive update of the science and technology of wood adhesives and bonded wood products. Information transfer during the 3-day symposium will take place via a workshop, technical and poster presentations, tabletop exhibits and a discussion forum on the following subject areas:

- Resin chemistry involving petroleum and biomass feedstocks
- Characterization of adhesive-wood interactions using new analytical techniques
- Durability of wood bonds
- Adhesive aspects of wood-based composites
- Performance of the adhesives in engineered wood products
- Current and future markets for wood adhesives and bonded wood products
- General and poster sessions

This symposium is sponsored by the USDA Forest Service, Forest Products Laboratory in cooperation with the Forest Products Society. As additional information on the program is developed, it will be available at: <http://www.forestprod.org>

For more information contact:

Forest Products Society
2801 Marshall Court, Madison, WI 53705-2295, USA.
Tel.: 608-231-1361, ext. 208; Fax: 608-231-2152;
E-mail: conferences@forestprod.org
Website: www.forestprod.org

2006**Announcement and Call for Papers**

January 15–20, 2006. Gordon Conference on Composites, Ventura, California, USA. The conference program is nearing completion and can be viewed at:

www.grc.org/programs/2006/composit.htm

Currently there are sessions in:

Biocomposites and Biological Applications

Self Healing Materials

Fracture Behavior

New Experimental Methods and Mechanics

Optical and Electrical Phenomena

New Process and Analysis Methods

New Applications

New Reinforcements

You are cordially invited to attend and participate in the lively discussion and debate that these conference are renowned for.

Please register to attend. The website for registration is: www.grc.org/

If you would like to present a poster, please e-mail a title and brief abstract to the Vice Chair, Ton Peijs at t.peijs@qmul.ac.uk

The 29th Annual Meeting of the Adhesion Society will take place on February 19–22, 2006, at the Radisson Riverwalk Hotel, Jacksonville, Florida. The Particle Division of the Society wishes to determine participant interest in the subject of “Adhesion at the Nanoscale, and its Consequences”. To that end, responses of interest, and potential papers, are being sought in the following areas:

Nanoscale adhesion measurement techniques;

Nanoparticle (nanoclusters, nanotubes, etc.) adhesion, and its consequences;

Nanoparticle removal (during semiconductor manufacture, CMP processing, etc.);

Nanoparticle coalescence;

Bioparticle (bacteria, cells, viruses, etc.) adhesion, and its consequences.

Please send indications of interest, possible presentations and suggestions to:

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Notice of Meeting and Call for Papers

February 19–22, 2006, 29th Annual Meeting of The Adhesion Society, Inc., Radisson Riverwalk Hotel, Jacksonville, Florida, USA. A full program, focused on the application of adhesion science to the solution of technical, is planned.

Topics of Emphasis for the meeting are solicited in all areas of adhesion science and technology, with emphasis on:

- Surface Interactions
- Contact Mechanics
- Bioadhesion
- Particle Adhesion
- Pressure Sensitive Adhesion
- Structural Adhesives
- High Throughput Adhesion Testing
- Corrosion and Adhesion
- Adhesion of/to Patterned Surfaces
- Interfaces in Electronic Systems

A session on “Molecular Mechanisms of Polymer Adhesion and Fracture,” which opens the meeting, will honor Professor Hugh Brown, who has been selected to receive the *Adhesion Society Award for Excellence in Adhesion Science, Sponsored by 3M*.

A Poster Session, which covers all topics related to adhesion science, will be an integral part of the meeting.

An Exhibition of equipment and literature relating to adhesion science will be held in conjunction with the Annual Meeting. For more information, contact The Adhesion Society Home Office, 540-231-7257 or <adhesoc@vt.edu>.

A two-day Short Course on Adhesion will be held on February 19–22, 2006, just prior to the Annual Meeting.

Submission of Short Abstracts

Authors wishing to present a paper or a poster should submit short abstracts of 150–250 words, *ELECTRONICALLY*, to The Adhesion Society Home Office, <adhesoc@vt.edu>, by August 15, 2005.

If you wish to target your abstract for a particular session, so indicate on the abstract. **Please underline** the name of the presenting author and include contact information. Authors will be informed of the status of their papers by October 15, 2005.

Submission of Extended Abstracts

Authors of accepted papers will receive instruction for preparation of extended abstracts (maximum of three (3) pages). Extended abstracts must be submitted no later than **December 1, 2005**, for inclusion in the bound meeting proceedings.

Submission of the extended abstracts will be accepted *ELECTRONICALLY*, in Microsoft Word compatible format, at the Adhesion Society home office, <adhesoc@vt.edu>.

The Website address is: <http://www.adhesionsociety.org>

The 2004 de Bruyne Medal of the Society of Adhesion and Adhesives will be awarded to Dr. William A. Lees, formerly of Permabond, at the major international conference on adhesion and adhesives [Adhesion 05], which is to be held at St. Catherine's College in Oxford, UK, on 7–9 September 2005. Dr. Lees will also deliver a paper entitled: *De Bruyne: Legend and Legacy*. There have been only three previous recipients of the Award: Dr. Stephanie Wellman of Permabond in 1996, Dr. Iain Webster of Smith and Nephew in 1999 and Dr. Michael Owen of Dow Corning in 2001.

The de Bruyne medal is named in honour of the founder of Aero Research Limited: Norman de Bruyne, FREng, FRS [1904–1997]. De Bruyne was a multi-disciplined scientist who had the ability and foresight to translate theoretical science into very practical, commercial applications. Three examples are: the development, in 1936, of the first structural composite [Gordon Aerolite[®]] for use in aircraft; in 1942 the invention of Redux[®], a synthetic heat-curing adhesive for structural bonding and patenting, in 1938, the concept of metal honeycomb. All three concepts are still widely used in the aerospace industry. The medal is presented to an individual who displays these characteristics. It is an acknowledgment of the recipient's personal contribution to innovation in the field of adhesives.

Dr. Lees has had a distinguished 35-year career as Technical Director with Permabond. He made significant advances in very varied fields within the adhesion and adhesive disciplines as well as being responsible for establishing the entire *modus operandi* of the company which was to become Permabond. His achievements include: the development of chemical techniques for soil stabilisation in, for example, the construction of tunnels and dams; the development of a range of anaerobic adhesives which were manufactured by novel techniques and which ultimately led to the so-called toughened acrylic adhesives; the introduction of the first cyanoacrylate adhesives manufacture to the UK. Adhesive innovations by Dr. Lees and his team have significantly advanced the construction technologies of the automotive industry [the ECV3 the first all bonded aluminium car], civil engineering [gas pipe repair] and defence [Law 80 rocket launcher]. One of his enduring legacies, apart from his numerous papers and books, is the development of the expert system "PAL" used for guiding adhesive selection by the end-user.

The Medal Committee comprises members of the Society for Adhesion and Adhesives [SAA], TWI and Huntsman Advanced Materials [originally Aero Research Limited/Ciba]. The CEO of Huntsman Advanced Materials, Paul Hulme, is to present the award to Dr. Lees.

Nominations are now being sought for a de Bruyne medallist for 2006. An application form is to be found on the SAA Website: <http://www.uksa.org>

For further information contact:

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Forthcoming Book

Adhesion – Current Research and Applications

Edited by Wulff Possart,
Universität des Saarlandes,
Saarbrücken, Germany

Thirty-four international authors provide contributions based on their lectures at the 7th European Adhesion Conference EURADH 2004 in Freiburg, Germany in September 2004.

Presenting a comprehensive survey of the latest research and development in the area of adhesion, this book also describes key aspects of applications of adhesion and adhesives that are of importance in microtechnology, transportation, coatings, medicine, surface treatment and engineering. It is a multidisciplinary guide to research applications and advanced technologies of adhesion.

Table of Contents:

Adhesive Interphases and Fundamental Adhesion
Adhesion and Biology
Chemistry for Adhesives
Pretreatment and Surface Chemistry of Adherends
Mechanics and Non-Destructive Testing of Adhesive Joints
Ageing and Durability in Adhesive Joints
Advanced Adhesive Technology

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